

KEMET Part Number: C0603X101J3GACTU
(C0603X101J3GAC7867)

SMD Comm COG Flex, Ceramic, 100 pF, 5%, 25 VDC, COG, SMD, MLCC, FT-CAP, Ultra-Stable, 0603



Dimensions

| Chip Size | 0603 |
|-----------|------------------|
| L | 1.6mm +/-0.17mm |
| W | 0.8mm +/-0.15mm |
| T | 0.8mm +/-0.15mm |
| S | 0.58mm MIN |
| B | 0.45mm +/-0.15mm |

Packaging Specifications

| | |
|---------------------|------------------------|
| Weight: | 4600 ug |
| Packaging: | T&R, 180mm, Paper Tape |
| Packaging Quantity: | 4000 |

General Information

| | |
|--------------|---------------------------------|
| Series: | SMD Comm COG Flex |
| Style: | SMD Chip |
| Description: | SMD, MLCC, FT-CAP, Ultra-Stable |
| Features: | FT-CAP, Ultra-Stable |
| RoHS: | Yes |
| Termination: | Flexible Termination |
| Marking: | No |
| AEC-Q200: | No |
| Shelf Life: | 78 Weeks |
| MSL: | 1 |

Specifications

| | |
|---|---------------------------|
| Capacitance: | 100 pF |
| Measurement Condition: | 1 MHz 1.0Vrms |
| Capacitance Tolerance: | 5% |
| Voltage DC: | 25 VDC |
| Dielectric Withstanding Voltage: | 62.5 VDC |
| Temperature Range: | -55/+125°C |
| Temperature Coefficient: | COG |
| Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC): | 30 ppm/C, 1MegaHz 1.0Vrms |
| Dissipation Factor: | 0.1% 1 MHz 1.0Vrms |
| Aging Rate: | 0% Loss/Decade Hour |
| Insulation Resistance: | 100 GOhms |